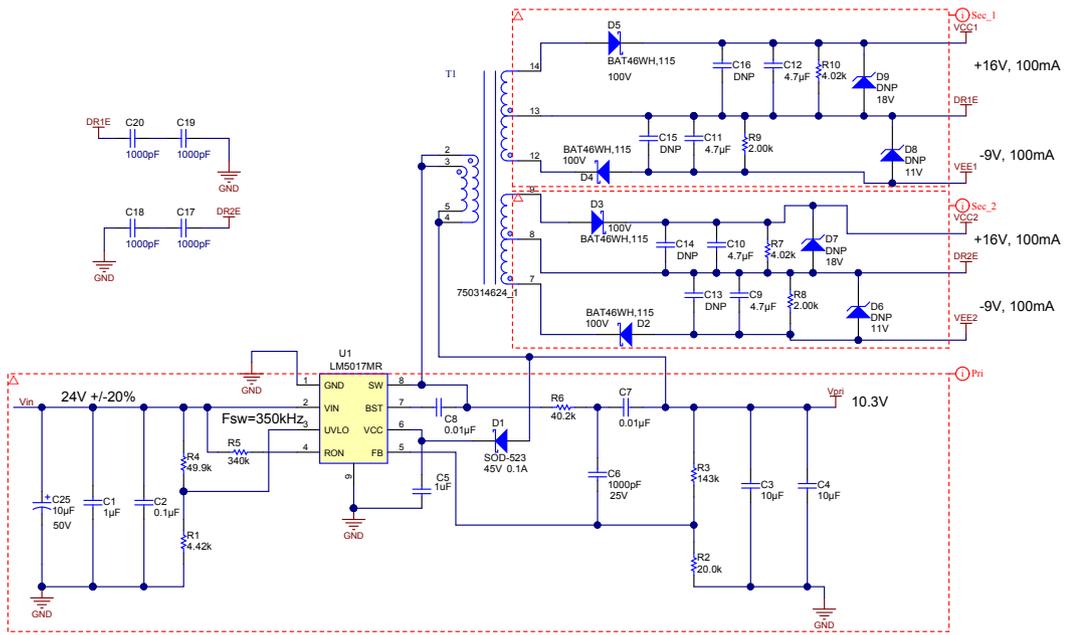
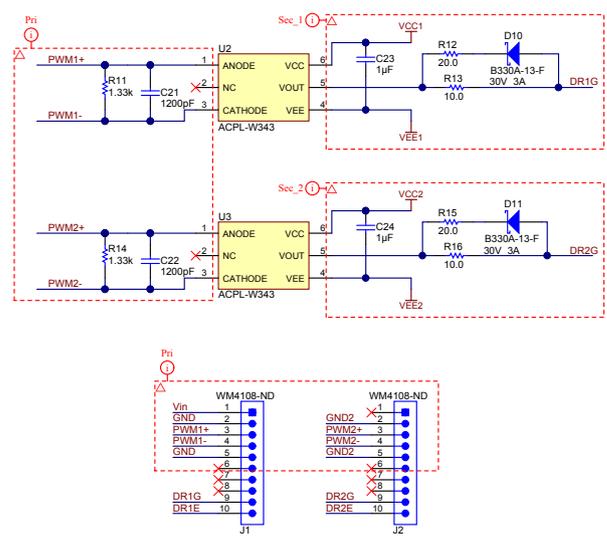


### Gate Drive Bias



### Optocoupler Gate Drives



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Designed for: Public Release | Mod. Date: 7/30/2014  
 Project Title: FlyBuck Driver Card  
 Number: TIDA00174 | Rev: 1  
 SVN Rev.: Not in version control  
 Assembly Variant: Variant name not interpreted  
 Drawn By: | File: FlyBuckDriverCard\_sch\_rev1.SchDoc | Size: B  
 Engineer: X. Fang | Contact: <http://www.ti.com/support>



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